

$V_{DRM}$  = 4500 V  
 $I_{TGQM}$  = 3000 A  
 $I_{TSM}$  =  $25 \times 10^3$  A  
 $V_{TO}$  = 1.9 V  
 $r_T$  = 0.53 mW  
 $V_{DC-link}$  = 2200 V

# Asymmetric Gate turn-off Thyristor **5SGA 30J4505**

Doc. No. 5SYA1204-04 Sept. 05

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

## Blocking

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state voltage	$V_{DRM}$	$V_{GR} \geq 2$ V			4500	V
Repetitive peak reverse voltage	$V_{RRM}$				17	V
Permanent DC voltage for 100 FIT failure rate	$V_{DC-link}$	Ambient cosmic radiation at sea level in open air.			2200	V

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state current	$I_{DRM}$	$V_D = V_{DRM}, V_{GR} \geq 2$ V			60	mA
Repetitive peak reverse current	$I_{RRM}$	$V_R = V_{RRM}, R_{GK} = \infty \Omega$			20	mA

## Mechanical data

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_m$		36	40	44	kN

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Pole-piece diameter	$D_p$	$\pm 0.1$ mm		75		mm
Housing thickness	$H$		25.6		26.0	mm
Weight	$m$				1.3	kg
Surface creepage distance	$D_s$	Anode to Gate	33			mm
Air strike distance	$D_a$	Anode to Gate	15			mm

Note 1 Maximum rated values indicate limits beyond which damage to the device may occur

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## GTO Data

### On-state

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{T(AV)M}$	Half sine wave, $T_C = 85^\circ C$			1000	A
Max. RMS on-state current	$I_{T(RMS)}$				1570	A
Max. peak non-repetitive surge current	$I_{TSM}$	$t_p = ms, T_{vj} = 125^\circ C$ , sine wave After Surge: $V_D = V_R = 0 V$			$25 \times 10^3$	A
Limiting load integral	$I^2t$				$3.1 \times 10^6$	$A^2s$
Max. peak non-repetitive surge current	$I_{TSM}$	$t_p = ms, T_{vj} = 125^\circ C$ , sine wave After Surge: $V_D = V_R = 0 V$			$45 \times 10^3$	A
Limiting load integral	$I^2t$				$1.01 \times 10^6$	$A^2s$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_T$	$I_T = 3000 A, T_{vj} = 125^\circ C$			3.5	V
Threshold voltage	$V_{(T0)}$	$T_{vj} = 125^\circ C$			1.9	V
Slope resistance	$r_T$	$I_T = 500...4000 A$			0.53	$m\Omega$
Holding current	$I_H$	$T_{vj} = 25^\circ C$			50	A

### Turn-on switching

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	$di_T/dt_{cr}$	$T_{vj} = 125^\circ C, f = 200 Hz$			400	$A/\mu s$
Critical rate of rise of on-state current	$di_T/dt_{cr}$	$I_T = 3000 A, I_{GM} = 30 A, di_G/dt = 20 A/\mu s, f = 1 Hz$			800	$A/\mu s$
Min. on-time	$t_{on}$	$V_D = 0.5 V_{DRM}, T_{vj} = 125^\circ C$ $I_T = 3000 A, di/dt = 200 A/\mu s,$ $I_{GM} = 30 A, di_G/dt = 20 A/\mu s,$ $C_S = 6 \mu F, R_S = 5 \Omega$	100			$\mu s$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Turn-on delay time	$t_d$	$V_D = 0.5 V_{DRM}, T_{vj} = 125^\circ C$			3	$\mu s$
Rise time	$t_r$	$I_T = 3000 A, di/dt = 200 A/\mu s,$ $I_{GM} = 30 A, di_G/dt = 20 A/\mu s,$ $C_S = 6 \mu F, R_S = 5 \Omega$			6	$\mu s$
Turn-on energy per pulse	$E_{on}$				3	J

### Turn-off switching

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. controllable turn-off current	$I_{TGQM}$	$V_{DM} \leq V_{DRM}, di_{GQ}/dt = 40 A/\mu s,$ $C_S = 6 \mu F, L_S \leq 0.3 \mu H$			3000	A
Min. off-time	$t_{off}$	$V_D = 0.5 V_{DRM}, T_{vj} = 125^\circ C$ $V_{DM} \leq V_{DRM}, di_{GQ}/dt = 40 A/\mu s,$ $I_{TGQ} = I_{TGQM},$ $R_S = 5 \Omega, C_S = 6 \mu F, L_S = 0.3 \mu H$	100			$\mu s$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Storage time	$t_S$	$V_D = 0.5 V_{DRM}, T_{vj} = 125^\circ C$			25	$\mu s$
Fall time	$t_f$	$V_{DM} \leq V_{DRM}, di_{GQ}/dt = 40 A/\mu s,$ $I_{TGQ} = I_{TGQM},$			3	$\mu s$
Turn-on energy per pulse	$E_{off}$	$R_S = 5 \Omega, C_S = 6 \mu F, L_S = 0.3 \mu H$			11	J
Peak turn-off gate current	$I_{GQM}$				900	A

## Gate

### Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak reverse voltage	$V_{GRM}$				17	V
Repetitive peak reverse current	$I_{GRM}$	$V_{GR} = V_{GRM}$			20	mA

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	$V_{GT}$	$T_{vj} = 25^\circ C$ , $V_D = 24 V$ , $R_A = 0.1 \Omega$		1		V
Gate trigger current	$I_{GT}$			3		A

## Thermal

### Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Junction operating temperature	$T_{vj}$		0		125	°C
Storage temperature range	$T_{stg}$		0		125	°C

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double side cooled			12	K/kW
	$R_{th(j-c)A}$	Anode side cooled			22	K/kW
	$R_{th(j-c)C}$	Cathode side cooled			27	K/kW
Thermal resistance case to heatsink (Double side cooled)	$R_{th(c-h)}$	Single side cooled			6	K/kW
	$R_{th(c-h)}$	Double side cooled			3	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i$ (K/kW)	5.400	4.500	1.700	0.400
$\tau_i$ (s)	1.2000	0.1700	0.0100	0.0010

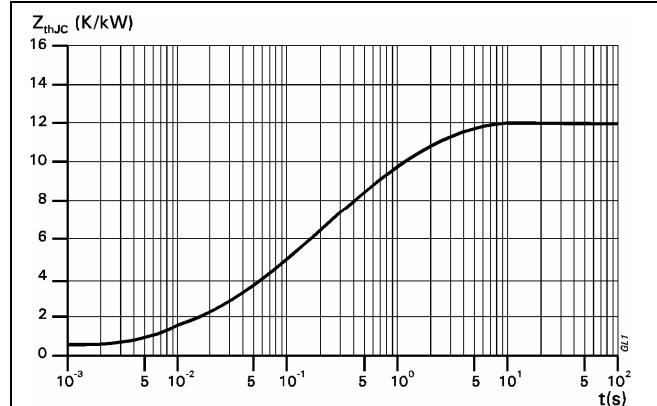
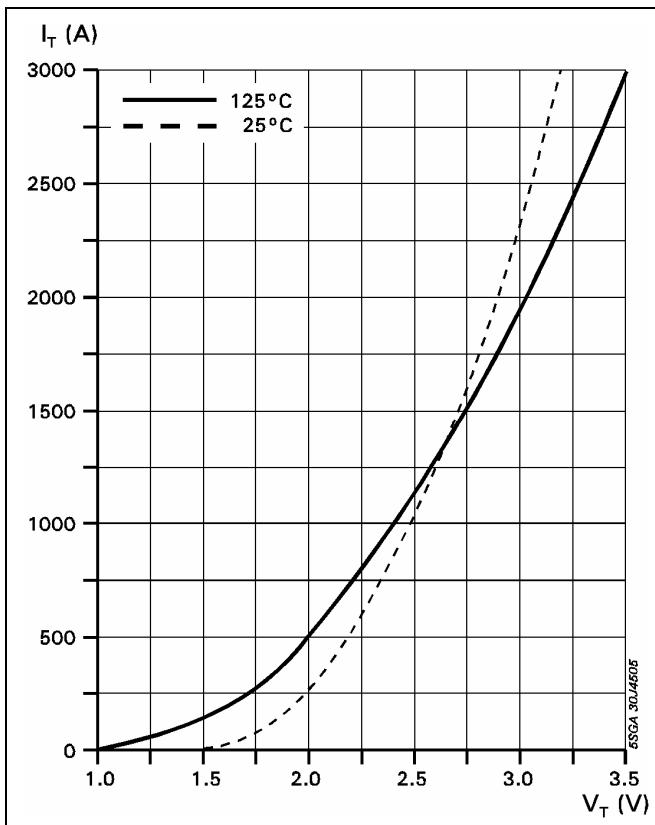
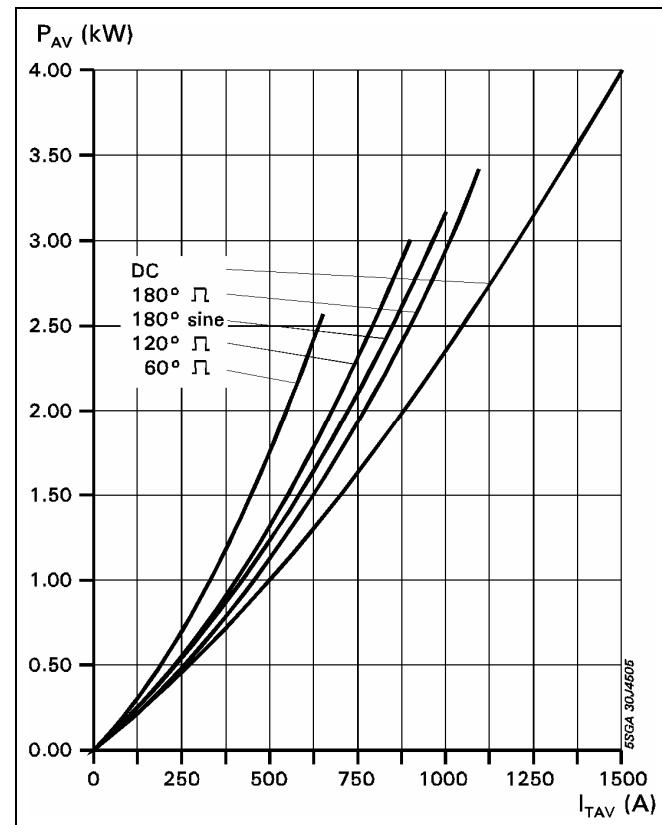
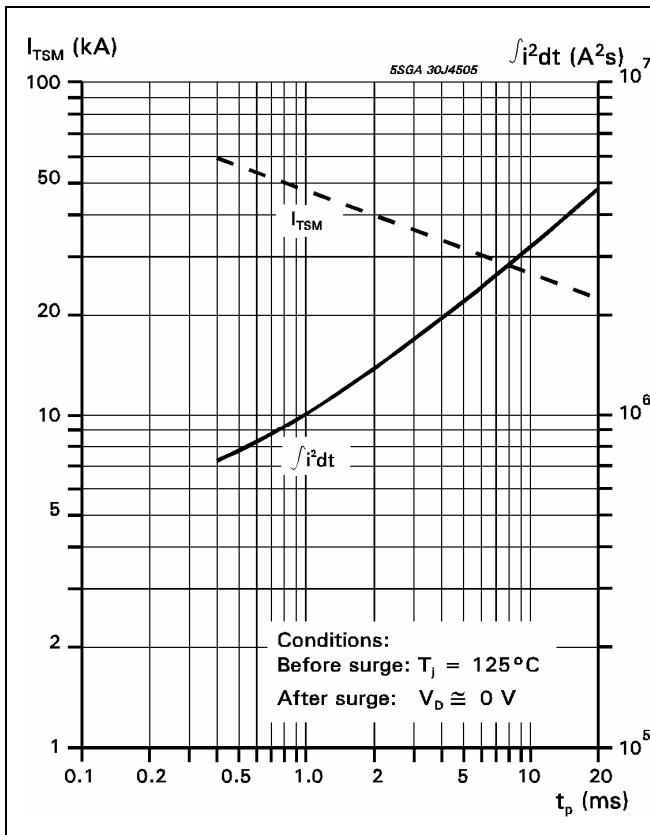
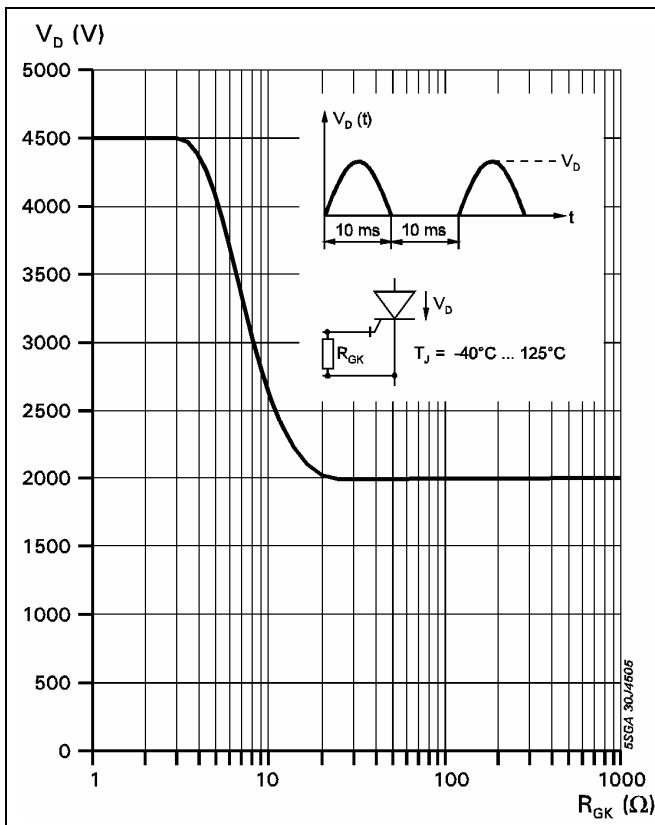
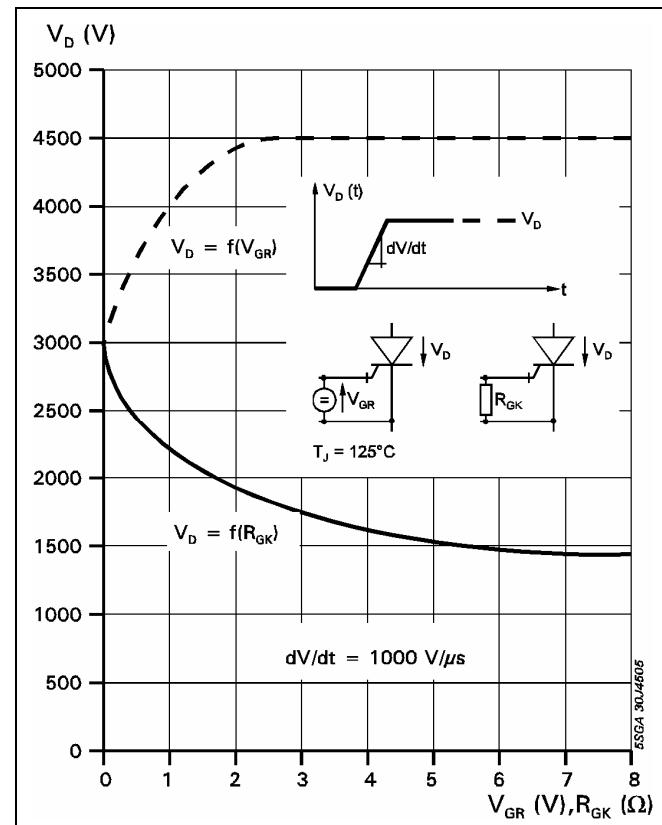


Fig. 1 Transient thermal impedance, junction to case

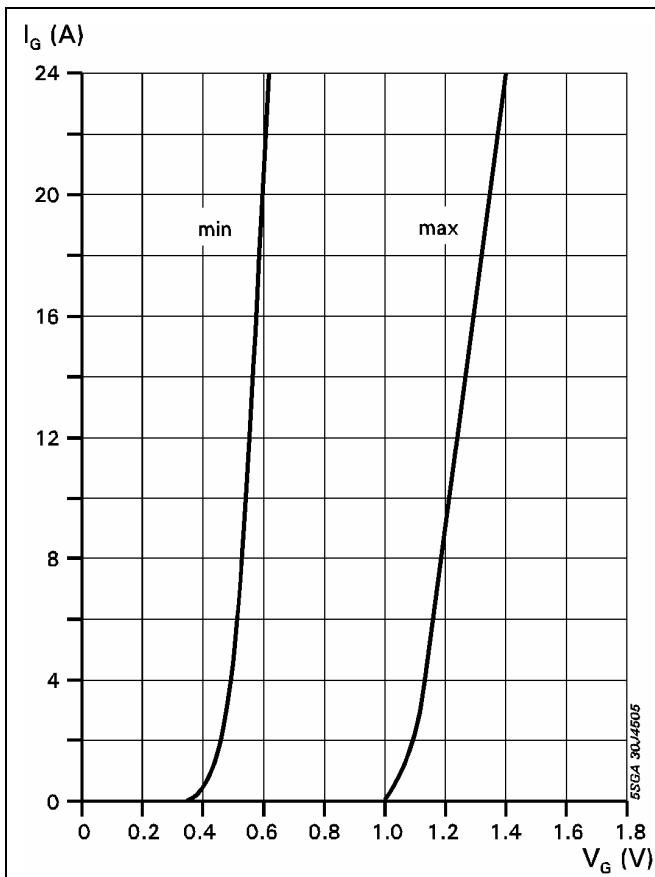
**Fig. 2** On-state characteristics**Fig. 3** Average on-state power dissipation vs. average on-state current**Fig. 4** Surge current and fusing integral vs. pulse width



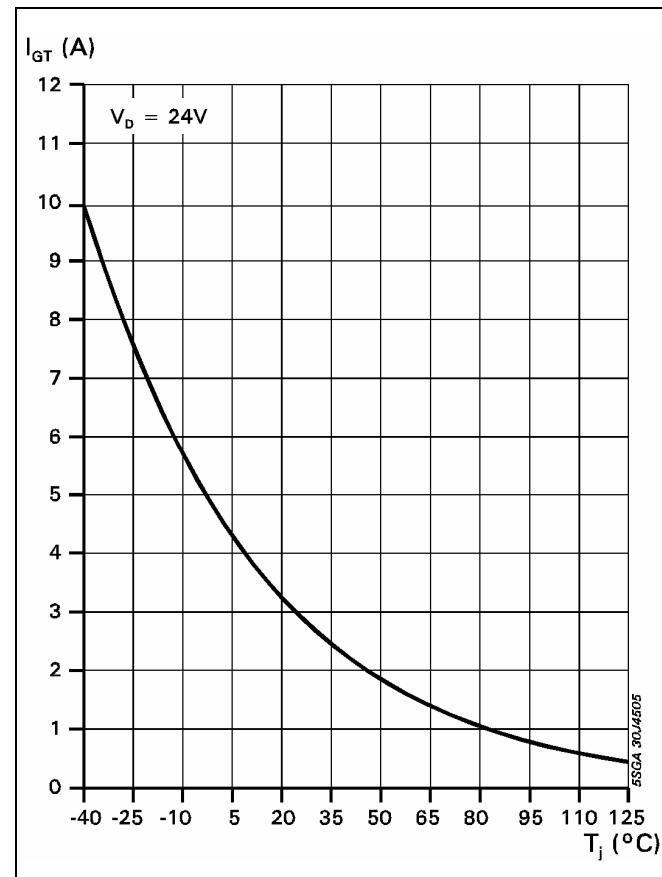
**Fig. 5** Forward blocking voltage vs. gate-cathode resistance



**Fig. 6** Static  $dv/dt$  capability; forward blocking voltage vs. neg. gate voltage or gate cathode resistance



**Fig. 7** Forward gate current vs. forward gate voltage



**Fig. 8** Gate trigger current vs. junction temperature

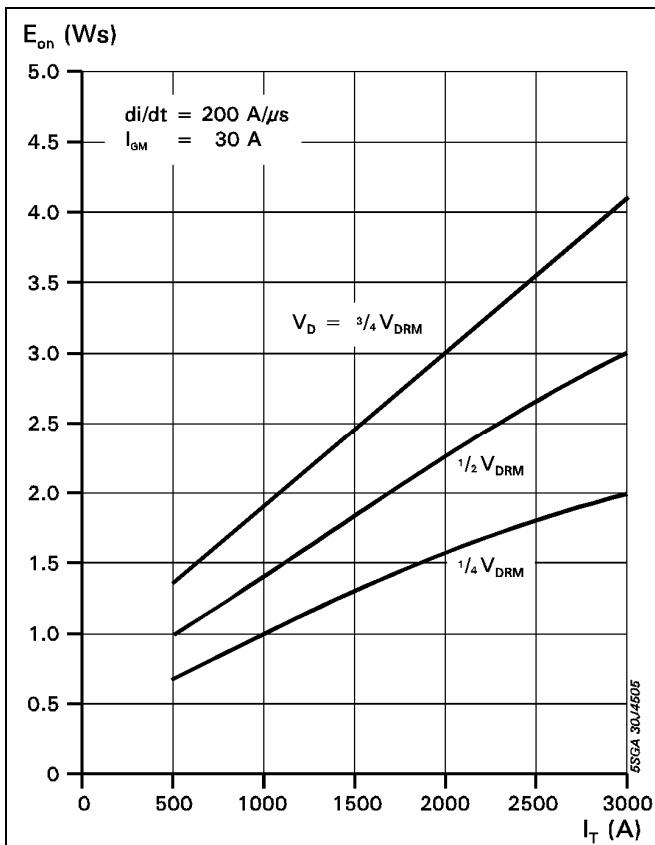


Fig. 9 Turn-on energy per pulse vs. on-state current and turn-on voltage

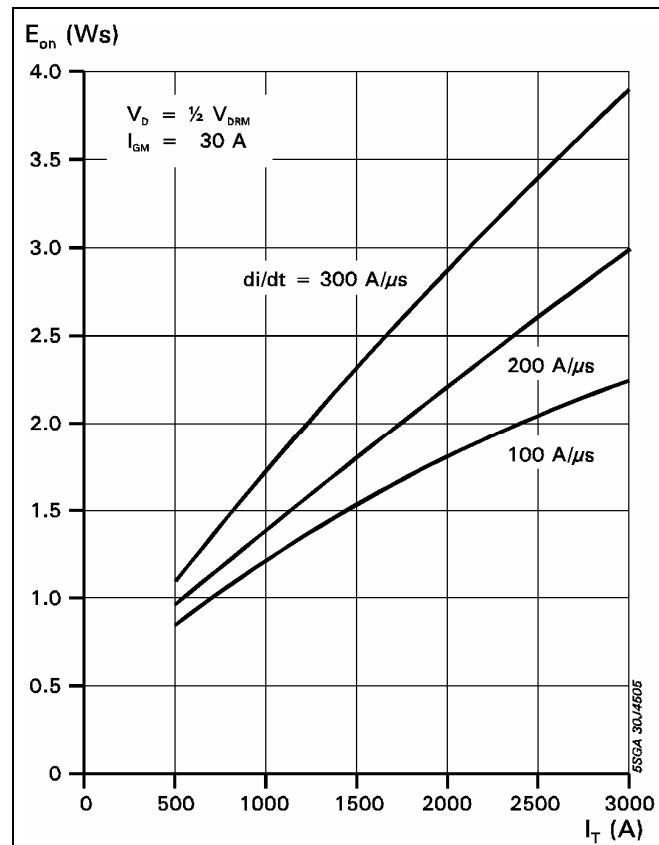


Fig. 10 Turn-on energy per pulse vs. on-state current and current rise rate

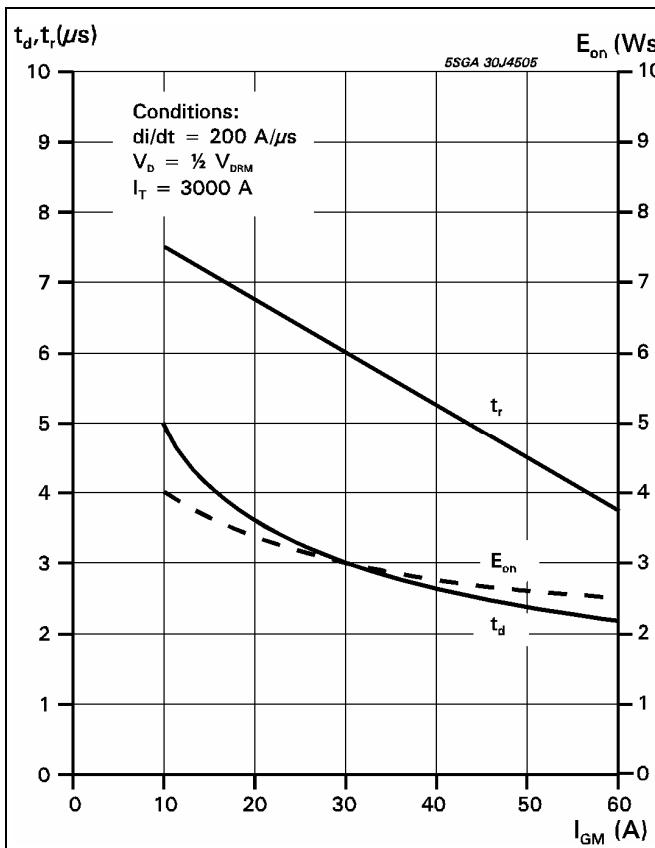
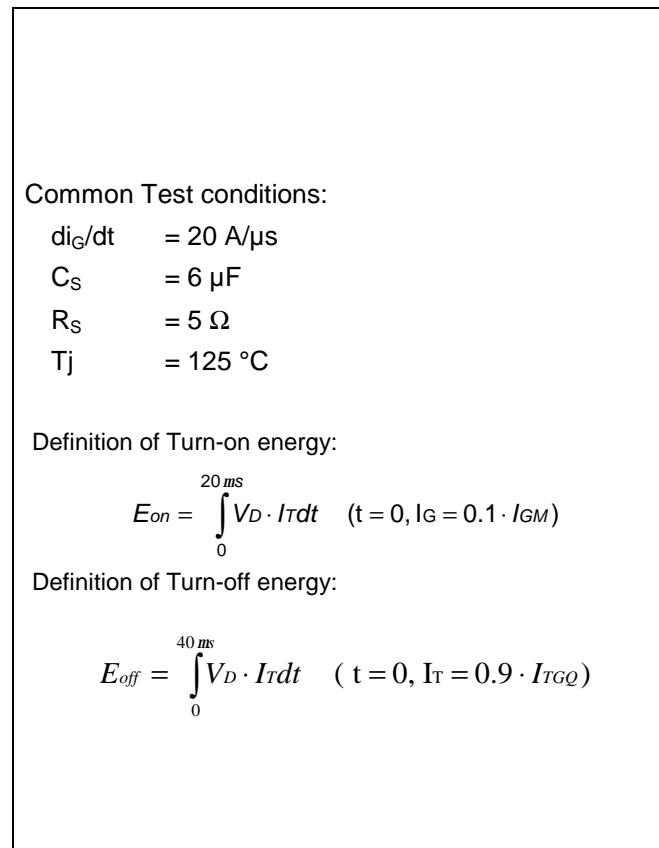
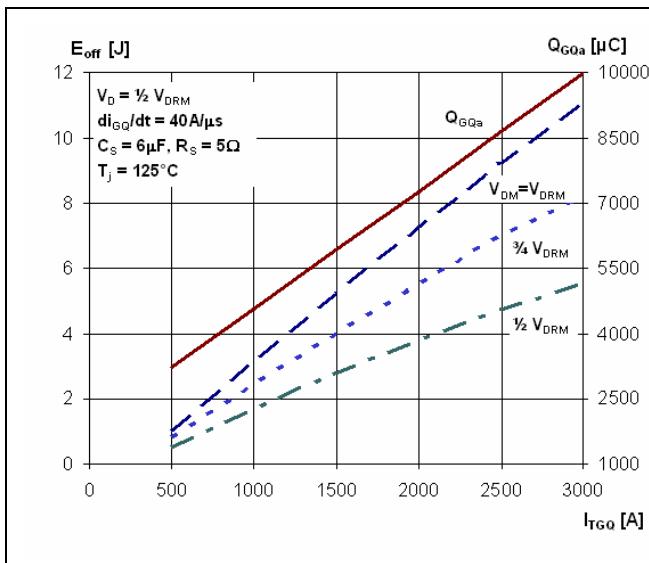
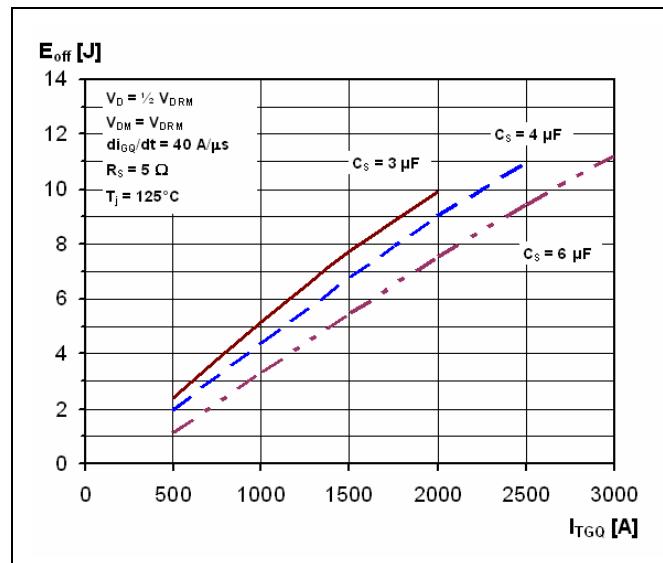


Fig. 11 Turn-on energy per pulse vs. on-state current and turn-on voltage

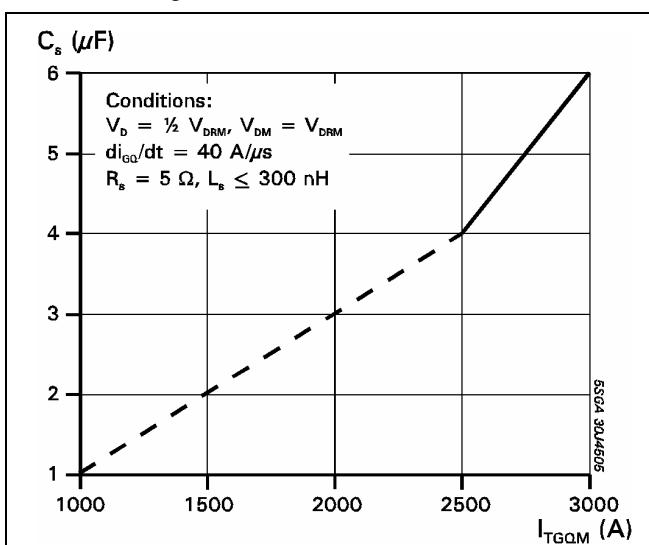




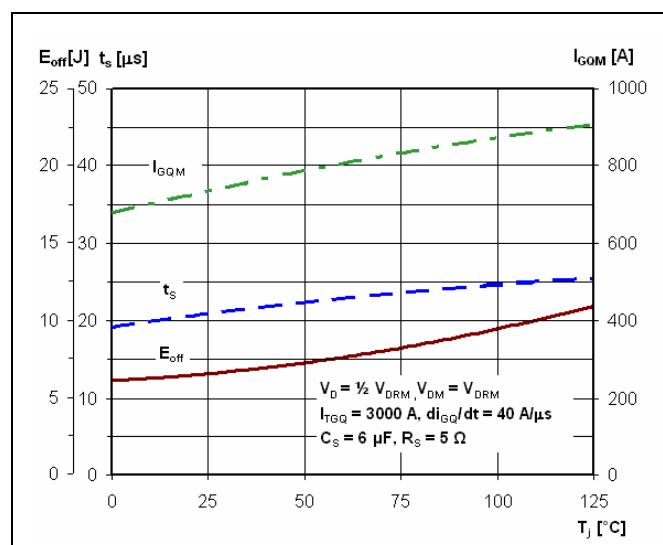
**Fig. 12** Turn-off energy per pulse vs. turn-off current and peak turn-off voltage, extracted gate charge vs. turn-off current



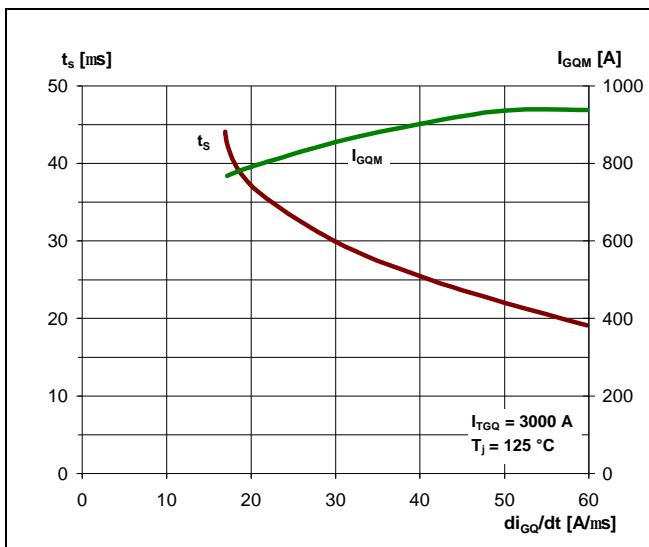
**Fig. 13** Turn-off energy per pulse vs. turn-off current and snubber capacitance



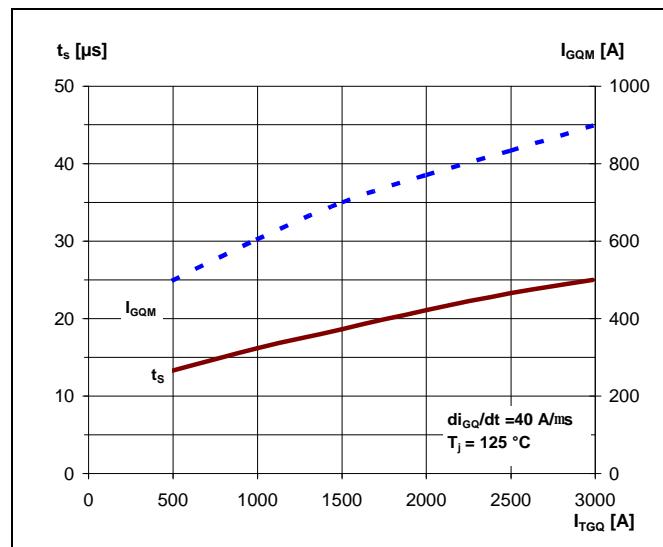
**Fig. 14** Required snubber capacitor vs. max allowable turn-off current



**Fig. 15** Turn-off energy per pulse, storage time and peak turn-off gate current vs. junction temperature



**Fig. 16** Storage time and peak turn-off gate current vs. neg. gate current rise rate



**Fig. 17** Storage time and peak turn-off gate current vs. turn-off current

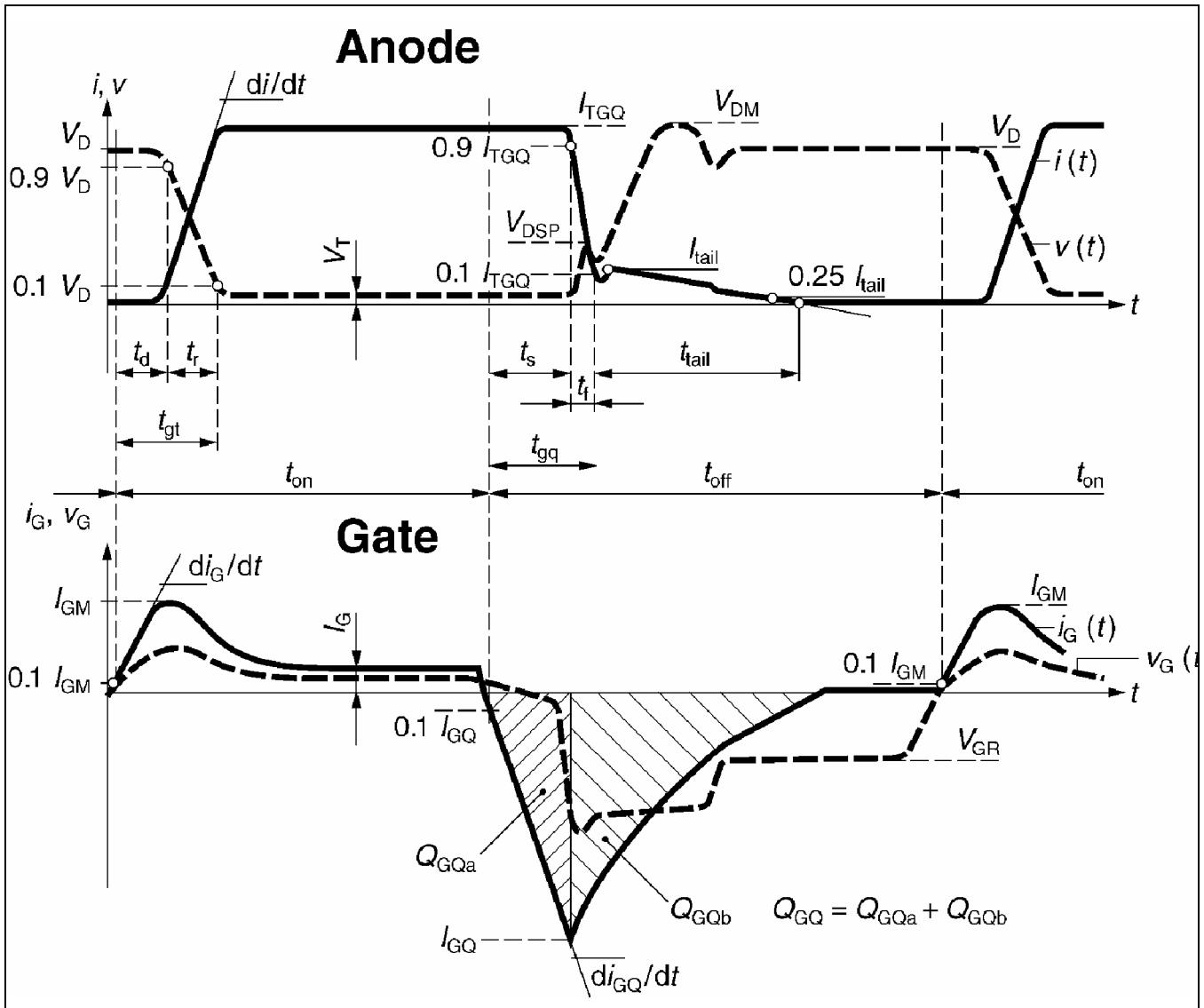
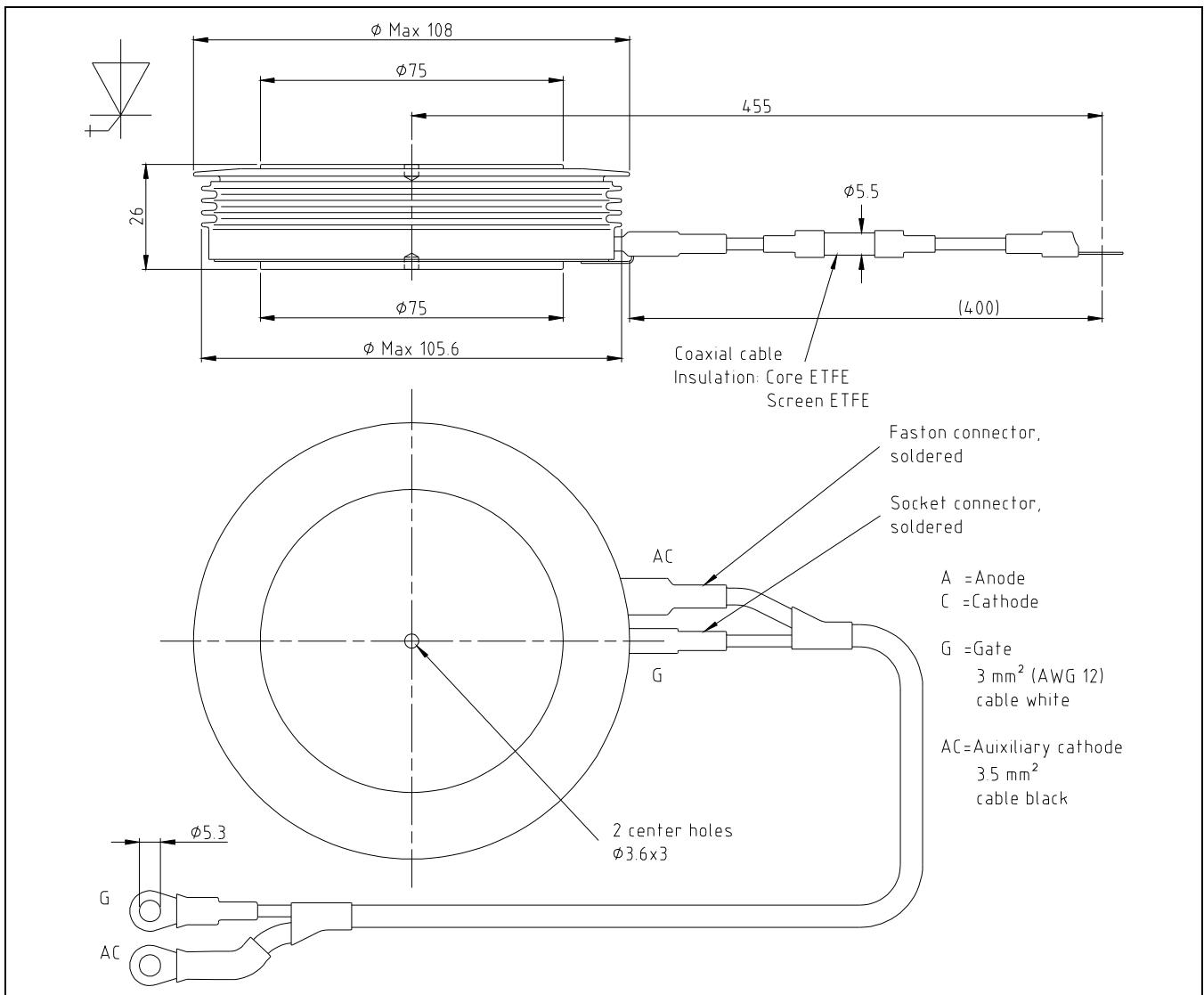


Fig. 18 General current and voltage waveforms with GTO-specific symbols



**Fig. 19** Outline drawing; all dimensions are in millimeters and represent nominal values unless stated otherwise

## Reverse avalanche capability

In operation with an antiparallel freewheeling diode, the GTO reverse voltage  $V_R$  may exceed the rate value  $V_{RRM}$  due to stray inductance and diode turn-on voltage spike at high  $di/dt$ . The GTO is then driven into reverse avalanche. This condition is not dangerous for the GTO provided avalanche time and current are below 10  $\mu s$  and 1000 A respectively. However, gate voltage must remain negative during this time. Recommendation :  $V_{GR} = 10...15$  V.

### Related documents:

- |           |  |
|-----------|--|
| 5SYA 2036 | Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors                                      |
| 5SYA 2046 | Cosmic Ray   |
| 5SZK 9104 | Specification of environmental class for pressure contact GTO, STORAGE available on request, please contact factory        |
| 5SZK 9105 | Specification of environmental class for pressure contact GTO, TRANSPORTATION available on request, please contact factory |

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

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